## APPLICATION DATA SHEET

Electronic Version v14 Stylesheet Version v14.0

> Title of Invention

Fluid Conduit and Process Therefor

Application Type:

regular, utility

Attorney Docket Number: CH2893

Correspondence address:

**Customer Number:** 

23906

\*23906\*

**Priority Data:** 

Doc.No: JP 2002-337779; Country - JP; Date: 2002-11-21 us-priority-claimed

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